HARP

PC3SD12NTZ **Series**

V_{DRM}: 600V, Cost effective Non-zero cross type **DIP 6pin** Phototriac Coupler for triggering



Description

PC3SD12NTZ Series Phototriac Coupler include an infrared emitting diode (IRED) optically coupled to an output Phototriac.

These devices feature full wave control and are ideal isolated drivers for medium to high current Triacs.

DIP package provides 5.0kV isolation from input to output with superior commutative noise immunity.

Features

- 1. High repetitive peak off-state voltage (VDRM : 600V)
- 2. Non-zero crossing functionality
- 3. 6 pin DIP package
- 4. Superior noise immunity (dV/dt : MIN. 1 000V/µs)
- 5. Lead-free components are also available (see Model Line-up section in this datasheet)
- 6. Double transfer mold construction (Ideal for Flow Soldering)
- 7. High isolation voltage between input and output $(V_{iso}(rms) : 5.0kV)$

Agency approvals/Compliance

- 1. Recognized by UL1577 (Double protection isolation), file No. E64380 (as model No. 3SD12)
- 2. Approved by CSA, file No. CA95323 (as model No. 3SD12)
- 3. Optionary available VDE Approved (*)(DIN EN 60747-5-2), file No. 40008189 (as model No. 3SD12)
- 4. Package resin : UL flammability grade (94V-0)

(*) DIN EN60747-5-2 : successor standard of DIN VDE0884. Up to Date code "RD" (December 2003), approval of DIN VDE0884. From Date code "S1" (January 2004), approval of DIN EN60747-5-2.

(**) Reinforced insulation type is also available. (PC3SF11YVZ Series)

Applications

1. Triggering for Triacs used to switch on and off devices which require AC Loads.

For example heaters, fans, motors, solenoids, and valves.

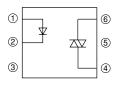
- 2. Triggering for Triacs used for implementing phase control in applications such as lighting control and temperature control (HVAC).
- 3. AC line control in power supply applications.

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Internal Connection Diagram

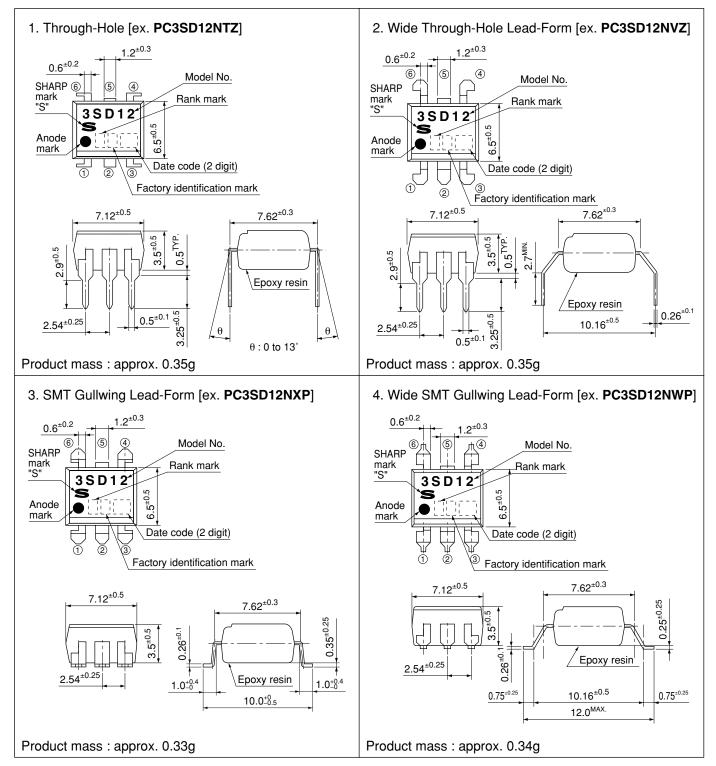




- 5 No external connection
- 6 Cathode/Anode

Outline Dimensions

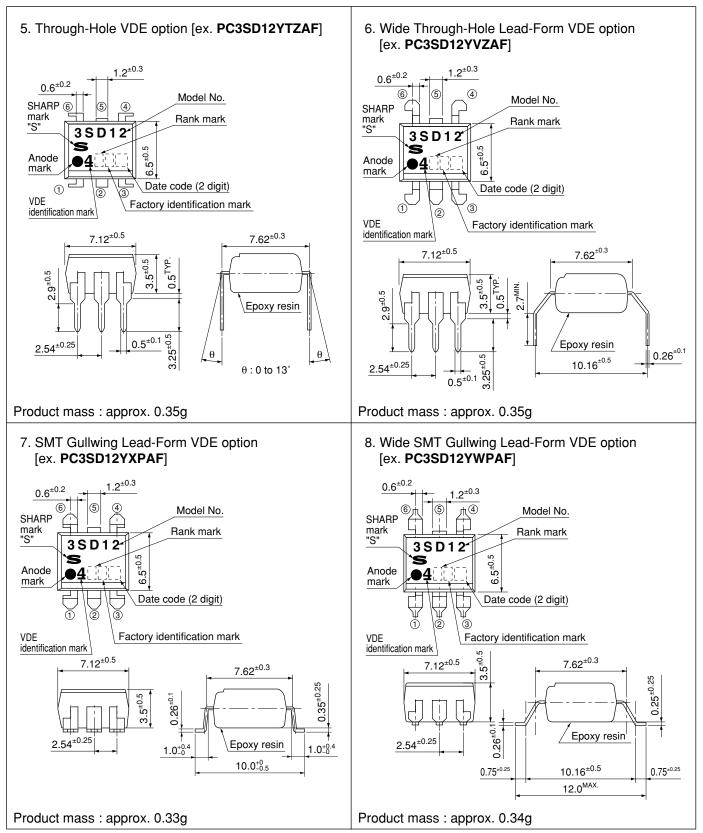
(Unit : mm)





Outline Dimensions





*Pin 5 is not allowed external connection



Date code (2 digit)

			ì		
1st o	ligit		2nd digit		
Year of p	roduction		Month of production		
Mark	A.D	Mark	Month	Mark	
А	2002	Р	January	1	
В	2003	R	February	2	
С	2004	S	March	3	
D	2005	Т	April	4	
Е	2006	U	May	5	
F	2007	V	June	6	
Н	2008	W	July	7	
J	2009	Х	August	8	
K	2010	А	September	9	
L	2011	В	October	0	
М	2012	С	November	N	
Ν	:	:	December	D	
	Year of p Mark A B C D E F H J K J K L M	A 2002 B 2003 C 2004 D 2005 E 2006 F 2007 H 2008 J 2009 K 2010 L 2011 M 2012	Year of production Mark A.D Mark A 2002 P B 2003 R C 2004 S D 2005 T E 2006 U F 2007 V H 2008 W J 2009 X K 2010 A L 2011 B M 2012 C	Year of productionMonth ofMarkA.DMarkMonthA2002PJanuaryB2003RFebruaryC2004SMarchD2005TAprilE2006UMayF2007VJuneH2008WJulyJ2009XAugustK2010ASeptemberL2011BOctoberM2012CNovember	

repeats in a 20 year cycle

Factory identification mark

Factory identification Mark	Country of origin		
no mark	I		
	Japan		
	Indonesia		
$\overline{\nabla}$	Philippines		
	China		

* This factory marking is for identification purpose only.

Please contact the local SHARP sales representative to see the actural status of the production.

Rank mark

Refer to the Model Line-up table

Absolute Maximum Ratings

Abs	Absolute Maximum Ratings						
	Parameter	Symbol	Rating	Unit			
Innut	Forward current	I_F	50	mA			
Input	Reverse voltage	V _R	6	V			
	RMS ON-state current	I _T (rms)	0.1	А			
Output	Peak one cycle surge current	I _{surge}	1.2 *3	А			
	Repetitive peak OFF-state voltage		600	V			
^{*1} Isolatic	on voltage	V _{iso} (rms)	5.0	kV			
	ing temperature	T _{opr}	-30 to +100	°C			
Storage	e temperature	T _{stg}	-55 to +125	°C			
*2Solderi	ng temperature	T _{sol}	270*4	°C			

*1 40 to 60%RH, AC for 1minute, f=60Hz *2 For 10s *3 f=50Hz sine wave

*4 Lead solder plating models: 260°C

Electro-optical Characteristics

1mm Soldering area

Elec	ctro-optical Characte	eristics					(T	$T_a=25^{\circ}C)$
	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Innut	Forward voltage		V _F	I _F =20mA	-	1.2	1.4	V
Input	Reverse current		I _R	$V_R=3V$	-	-	10	μΑ
	Repentitive peak OFF-state	current	I _{DRM}	$V_D = V_{DRM}$	_	—	1	μΑ
0 4 4	ON-state voltage		VT	I _T =0.1A	_	_	2.5	V
Output	Holding current		I _H	V _D =6V	0.1	_	3.5	mA
	Critical rate of rise of OFF-state voltage		dV/dt	$V_D = 1/\sqrt{2} \cdot V_{DRM}$	1 000	2 000	-	V/µs
Transfer	Minimum trigger current Rank A		I _{FT}	$V_D=6V, R_L=100\Omega$	-	-	10	mA
charac-	Isolation resistance	Isolation resistance		DC500V,40 to 60%RH	5×10 ¹⁰	1011	-	Ω
teristics	Turn-on time		t _{on}	$V_{D}=6V, R_{L}=100\Omega, I_{F}=20mA$	_	_	50	μs



■ Model Line-up (1) (Lead-free components)

Lead Form	Throug	gh-Hole	SMT G	ullwing	Wide Thre	ough-Hole			
Chinging Dockson					I _{FT} [mA]				
Shipping Package	50pcs/sleeve						Rank mark	$(V_D=6V,$	
DIN		Approved		Approved		Approved		$R_L=100\Omega$)	
EN60747-5-2		Appioved		Appioved		Approved			
Model No.	PC3SD12NTZAF	PC3SD12YTZAF	PC3SD12NXZAF	PC3SD12YXZAF	PC3SD12NVZAF	PC3SD12YVZAF	А	MAX.10	

Lead Form	Wide SM7	Γ Gullwing	SMT Gullwing Wide SMT Gullwing					
<u>01 D 1</u>	Sleeve		Taping					I _{FT} [mA]
Shipping Package	50pcs/sleeve		1 000pcs/reel				Rank mark	$(V_{D}=6V,$
DIN		Approved		Approved		Approved		$R_L=100\Omega$)
EN60747-5-2		Approved		Approved		Approved		
Model No.	PC3SD12NWZAF	PC3SD12YWZAF	PC3SD12NXPAF	PC3SD12YXPAF	PC3SD12NWPAF	PC3SD12YWPAF	А	MAX.10

■ Model Line-up (2) (Lead solder plating components)

Lead Form	Through-Hole SMT Gullwing Wide Through-Hole					ough-Hole		
Chimine Declares		Sleeve						
Shipping Package			Rank mark	$I_{FT}[mA]$ (V _D =6V,				
DIN		Annovad		Approved		Annovad		$R_L=100\Omega$)
EN60747-5-2		Approved		Approved		Approved		
Model No.	PC3SD12NTZA — PC3SD12NXZA — PC3SD12NVZA —				А	MAX.10		

Lead Form	Wide SMT Gullwing		SMT G	SMT Gullwing Wide SMT Gullwing					
Shipping Package	Sleeve		Taping				Rank mark	I _{FT} [mA] (V _D =6V,	
	50pcs/sleeve		1 000pcs/reel						
DIN		Approved		Approved		Annovad		$R_L=100\Omega$)	
EN60747-5-2		Approved		Approved		Approved			
Model No.	PC3SD12NWZA		PC3SD12NXPA		PC3SD12NWPA		А	MAX.10	

Please contact a local SHARP sales representative to inquire about production status.

Fig.1 Forward Current vs. Ambient Temperature

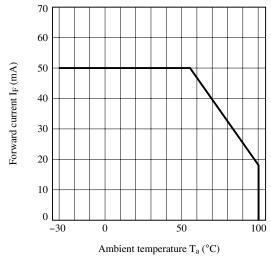
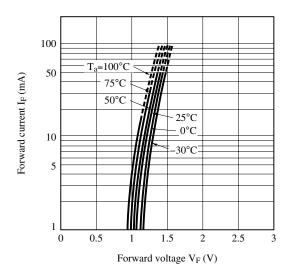


Fig.3 Forward Current vs. Forward Voltage





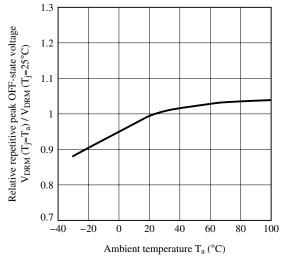


Fig.2 RMS ON-state Current vs. Ambient Temperature

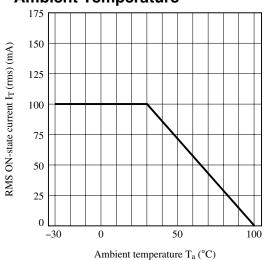


Fig.4 Minimum Trigger Current vs. Ambient Temperature

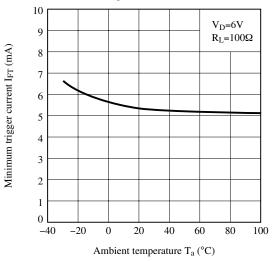


Fig.6 ON-state Voltage vs. Ambient Temperature

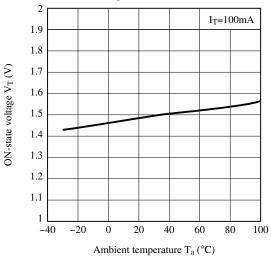




Fig.7 Holding Current vs. Ambient Temperature

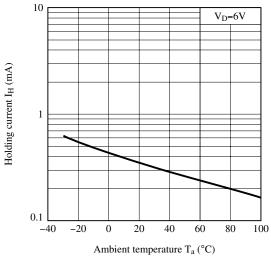
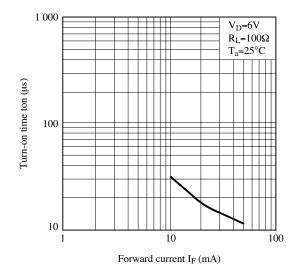
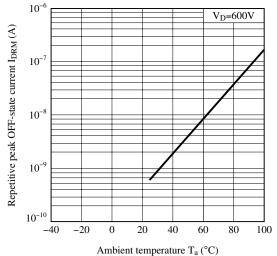


Fig.9 Turn-on Time vs. Forward Current



Remarks : Please be aware that all data in the graph are just for reference.

Fig.8 Repetitive Peak OFF-state Current vs. Ambient Temperature



Sheet No.: D2-A07701EN



Design Considerations

Design guide

In order for the Phototriac to turn off, the triggering current (I_F) must be 0.1mA or less.

Please refrain from using these devices in a direct drive configuration.

These Phototriac Coupler are intended to be used as triggering device for main Triacs.

Please ensure that the output rating of these devices will be sufficient for triggering the main output Triac of your choice. Failure to do may result in malfunctions.

In phase control applications or where the Phototriac Coupler is being by a pulse signal, please ensure that the pulse width is a minimum of 1ms.

For designs that will experience excessive noise or sudden changes in load voltage, please include an appropriate snubber circuit as shown in the below circuit.

Please keep in mind that Sharp Phototriac Couplers incorporate superor dV/dt ratings which can often eliminate the need for a snubber circuit.

Degradation

In general, the emission of the IRED used in Phototriac Couplers will degrade over time. In the case where long term operation and / or constant extreme temperature fluctuations will be applied to

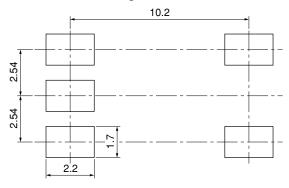
the devices, please allow for a worst case scenario of 50% degradation over 5years.

Therefore in order to maintain proper operation, a design implementing these Phototriac Couplers should provide at least twice the minimum required triggering current from initial operation.

Recommended Foot Print (reference)

SMT Gullwing Lead-form

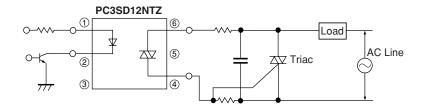
Wide SMT Gullwing Lead-form



(Unit : mm)



• Standard Circuit (Medium/High Power Triac Drive Circuit)



Note) Please add the snubber circuit according to a condition. Any snubber or varistor used for the above mentioned scenarios should be located

as close to the main output triac as possible.

☆ For additional design assistance, please review our corresponding Optoelectronic Application Notes.

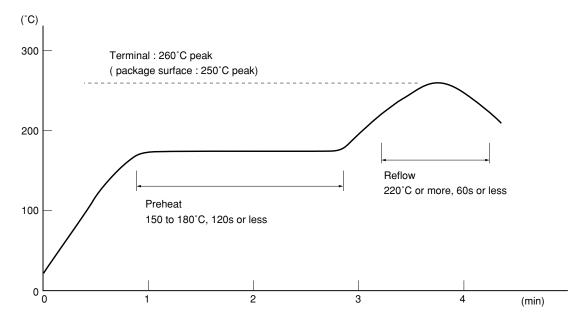


Manufacturing Guidelines

Soldering Method

Reflow Soldering:

Reflow soldering should follow the temperature profile shown below. Soldering should not exceed the curve of temperature profile and time. Please don't solder more than twice.



Flow Soldering :

Due to SHARP's double transfer mold construction submersion in flow solder bath is allowed under the below listed guidelines.

Flow soldering should be completed below 270°C and within 10s. Preheating is within the bounds of 100 to 150°C and 30 to 80s. Please don't solder more than twice.

Hand soldering

Hand soldering should be completed within 3s when the point of solder iron is below 400°C. Please don't solder more than twice.

Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.



• Cleaning instructions

Solvent cleaning :

Solvent temperature should be 45°C or below. Immersion time should be 3minutes or less.

Ultrasonic cleaning :

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

Recommended solvent materials :

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol.

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances : CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform) Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.



Package specification

• Sleeve package

1. Through-Hole or SMT Gullwing

Package materials

Sleeve : HIPS (with anti-static material) Stopper : Styrene-Elastomer

Package method

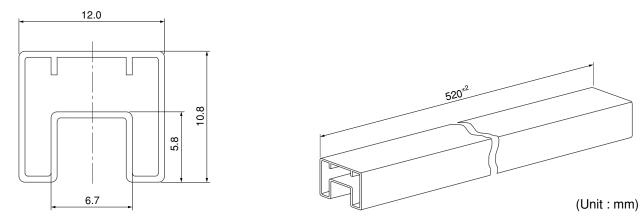
MAX. 50pcs of products shall be packaged in a sleeve.

Both ends shall be closed by tabbed and tabless stoppers.

The product shall be arranged in the sleeve with its anode mark on the tabless stopper side.

MAX. 20 sleeves in one case.

Sleeve outline dimensions



2. Wide Through-Hole or Wide SMT Gullwing

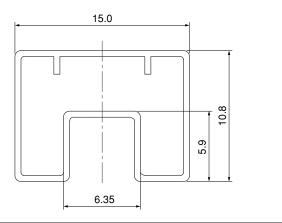
Package materials

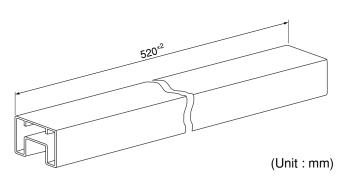
Sleeve : HIPS (with anti-static material) Stopper : Styrene-Elastomer

Package method

MAX. 50pcs of products shall be packaged in a sleeve.Both ends shall be closed by tabbed and tabless stoppers.The product shall be arranged in the sleeve with its anode mark on the tabless stopper side.MAX. 20 sleeves in one case.

Sleeve outline dimensions





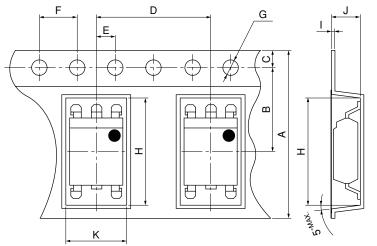


• Tape and Reel package

1. SMT Gullwing

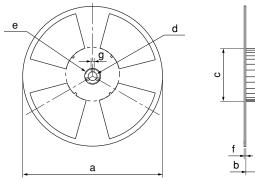
Package materials Carrier tape : A-PET (with anti-static material) Cover tape : PET (three layer system) Reel : PS

Carrier tape structure and Dimensions



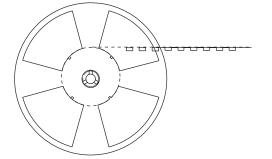
Dimensio	Dimensions List									
А	В	C	D	Е	F	G				
$16.0^{\pm 0.3}$	$7.5^{\pm0.1}$	$1.75^{\pm 0.1}$	12.0 ^{±0.1}	$2.0^{\pm 0.1}$	$4.0^{\pm 0.1}$	$\phi 1.5^{+0.1}_{-0}$				
Н	Ι	J	K							
$10.4^{\pm 0.1}$	$0.4^{\pm 0.05}$	$4.2^{\pm 0.1}$	$7.8^{\pm0.1}$							

Reel structure and Dimensions

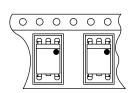


Dimensio	ns List	(Unit : mm)			
а	b	с	d		
330	$17.5^{\pm 1.5}$	100 ^{±1.0}	13 ^{±0.5}		
e	f	g			
23 ^{±1.0}	$2.0^{\pm 0.5}$	2.0 ^{±0.5}			

Direction of product insertion



Pull-out direction



[Packing : 1 000pcs/reel]

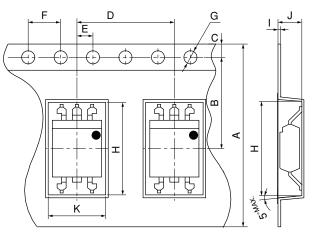


2. Wide SMT Gullwing

Package materials

Carrier tape : A-PET (with anti-static material) Cover tape : PET (three layer system) Reel : PS

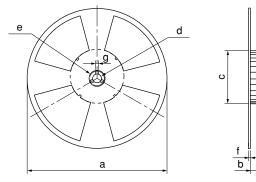
Carrier tape structure and Dimensions



1 Init	mm)
Unit	mm)

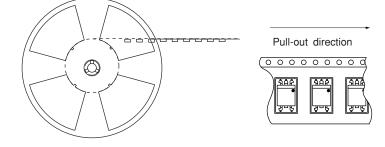
Dimensions List (Unit								
А	В	C	D	Е	F	G		
24.0 ^{±0.3}	$11.5^{\pm 0.1}$	$1.75^{\pm 0.1}$	$12.0^{\pm0.1}$	$2.0^{\pm 0.1}$	$4.0^{\pm 0.1}$	φ1.5 ^{+0.1}		
Н	Ι	J	K					
$12.2^{\pm 0.1}$	$0.4^{\pm 0.05}$	$4.15^{\pm0.1}$	$7.6^{\pm 0.1}$					

Reel structure and Dimensions



Dimensions List		(Unit : mm)	
а	b	с	d
330	25.5 ^{±1.5}	$100^{\pm 1.0}$	13 ^{±0.5}
e	f	g	
23 ^{±1.0}	2.0 ^{±0.5}	2.0 ^{±0.5}	

Direction of product insertion



[Packing: 1 000pcs/reel]

SHARP

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(i) The devices in this publication are designed for use in general electronic equipment designs such as:

- --- Personal computers
- --- Office automation equipment
- --- Telecommunication equipment [terminal]
- --- Test and measurement equipment
- --- Industrial control
- --- Audio visual equipment
- --- Consumer electronics

(ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:

- --- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- --- Traffic signals
- --- Gas leakage sensor breakers
- --- Alarm equipment
- --- Various safety devices, etc.

(iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:

- --- Space applications
- --- Telecommunication equipment [trunk lines]
- --- Nuclear power control equipment
- --- Medical and other life support equipment (e.g., scuba).

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